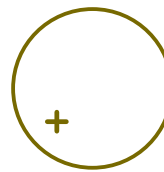


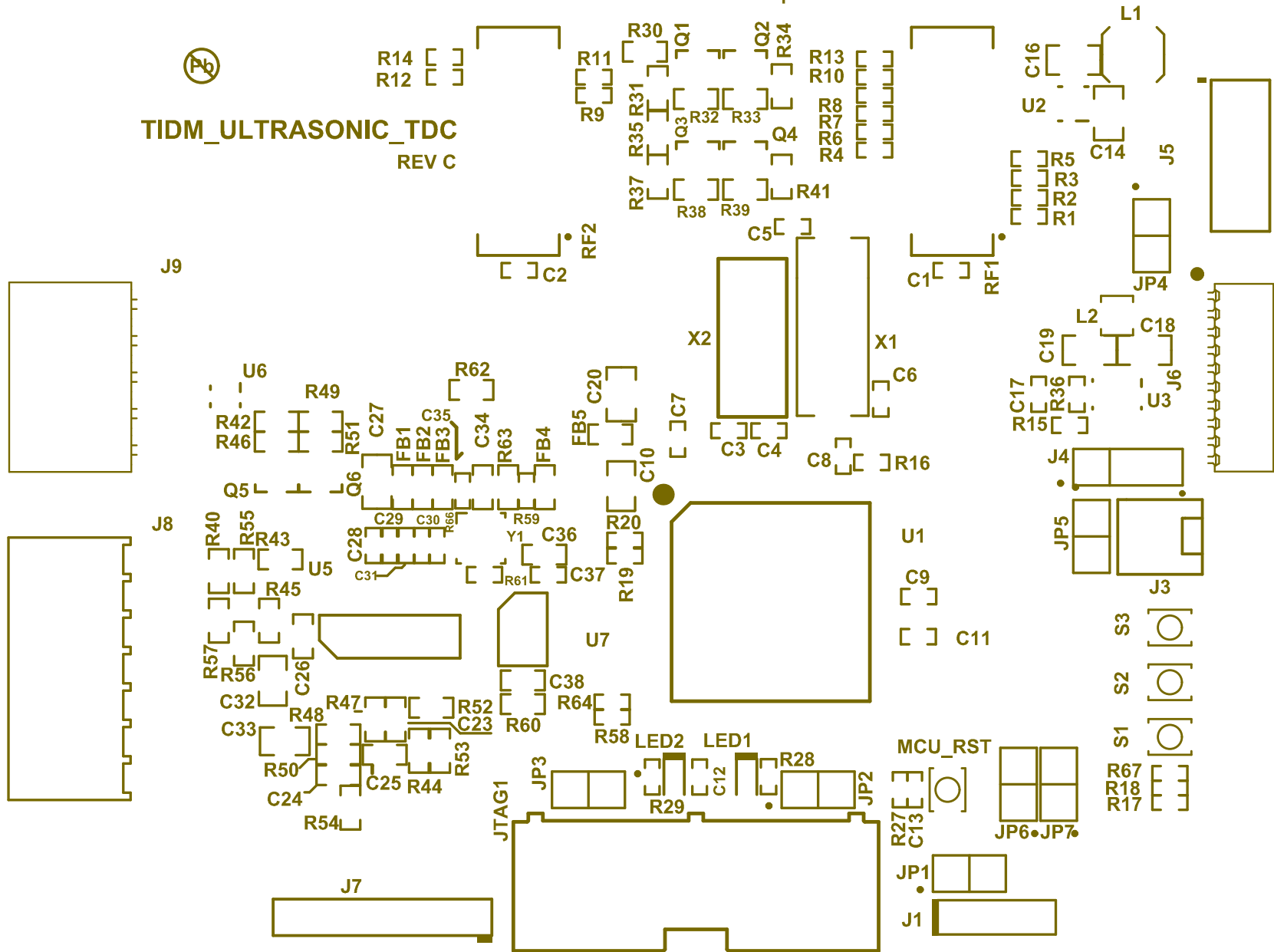


TEXAS
INSTRUMENTS

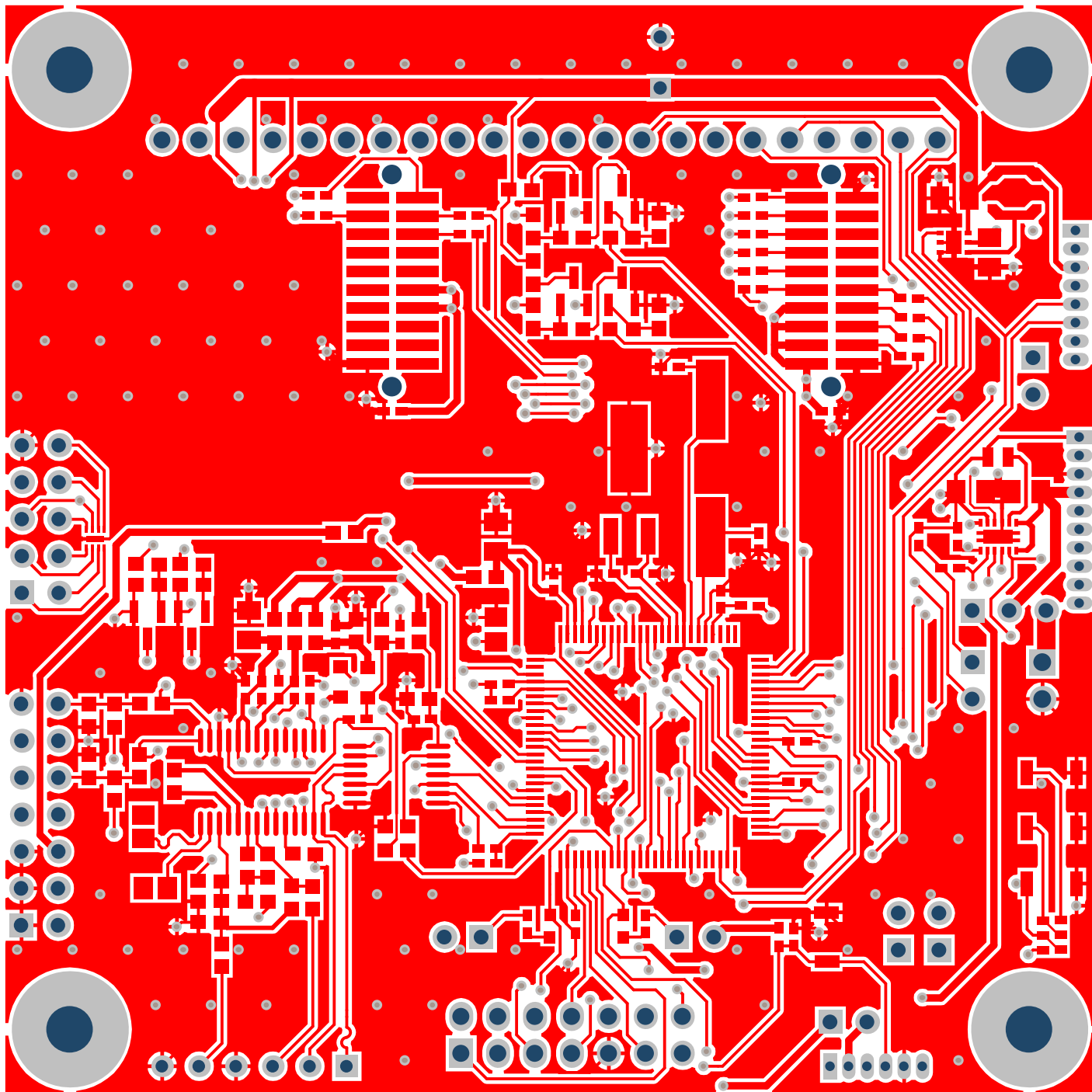
C15



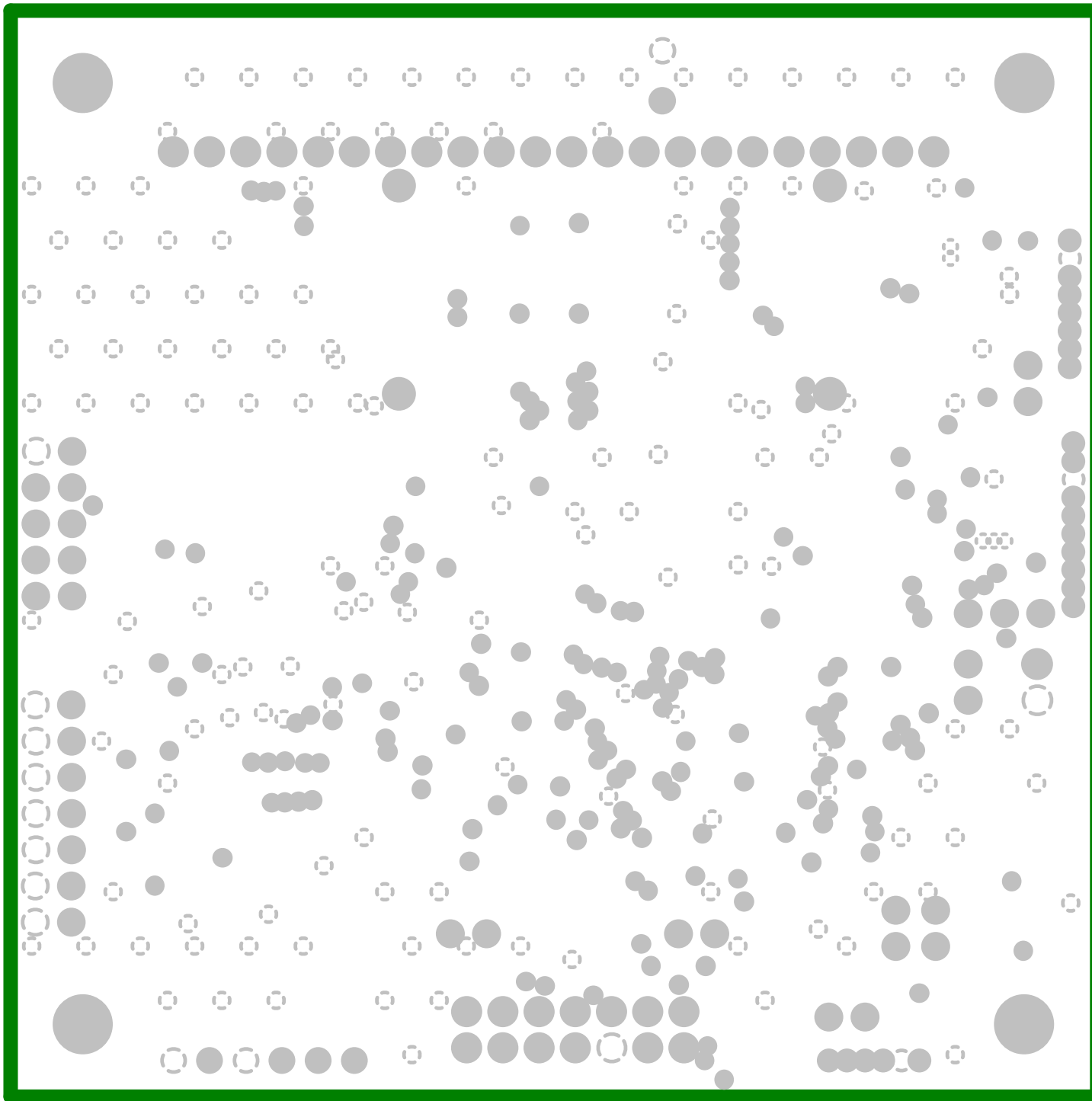
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REV C



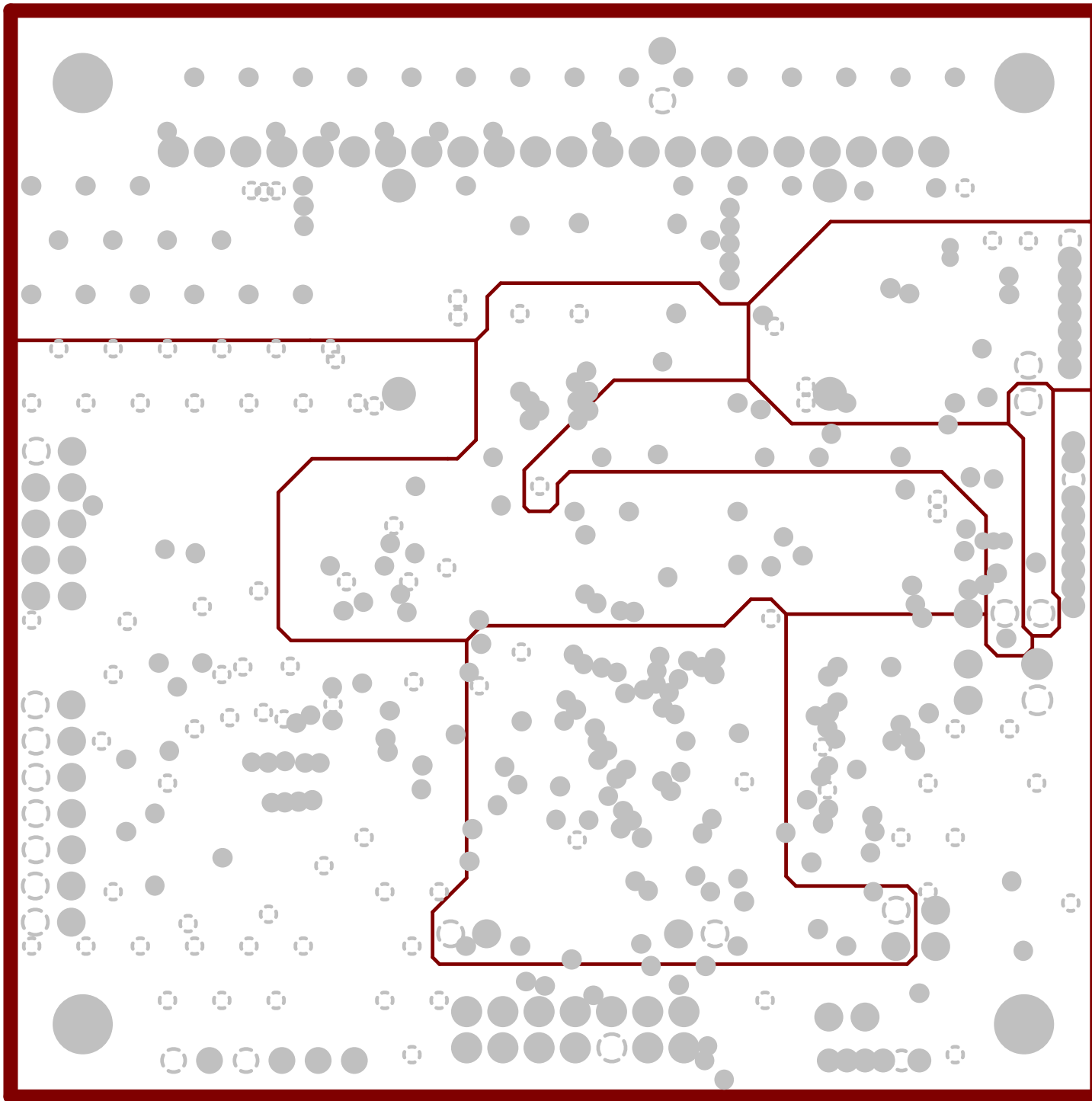
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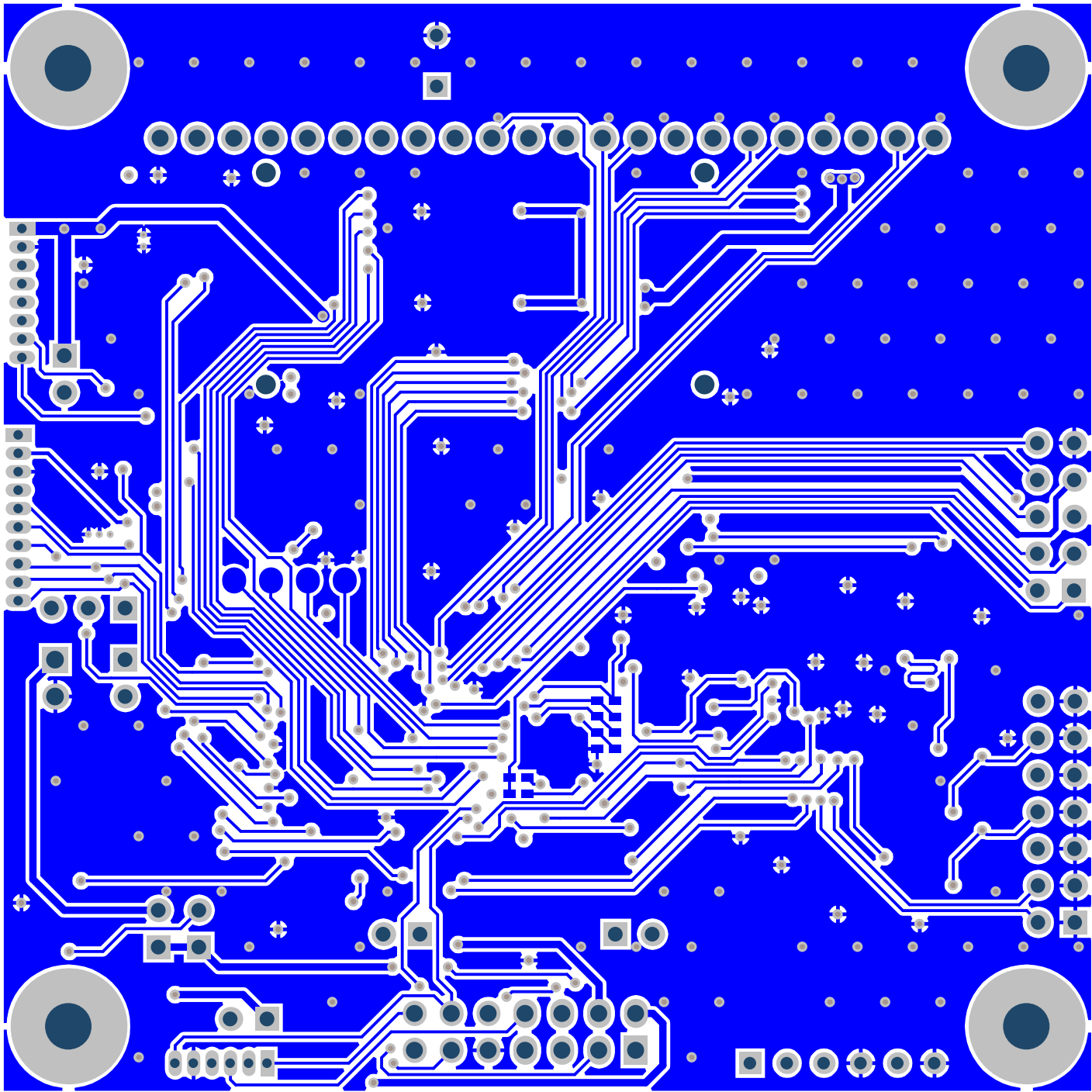
Top Layer



Internal Plane 1



Internal Plane 2



Bottom Layer



R21
R22
R23
R26
R24
R25



TDM_ULTRASONIC_TDC
REV C

Bottom Overlay

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